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Chemical vapour deposition growth and Raman characterization of graphene layers and carbon nanotubes


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Abstract. Single-layer graphene films were grown by chemical vapour deposition (CVD) on Cu foil. The CVD process was complemented by plasma enhancement to grow also vertically aligned multiwalled carbon nanotubes using Ni nanoparticles as catalyst. The obtained samples were characterized by Raman spectroscopy analysis. Nature of defects in the samples and optimal growth conditions leading to achieve high quality of graphene and carbon nanotubes are discussed.

1. Introduction
Graphene, due to its outstanding properties as high electrical mobility [1], high thermal conductivity [2] and exceptionally low absorbance [3] play a key role in scientific and technological development. Up-to-date application of graphene in integrated devices requires wafer scale deposition technology with controllable number of graphene layers. On the other hand, the implementation of graphene as transparent conductor needs reproducible deposition of single or few layers. Especially, synthesis of bilayer graphene becomes increasingly desirable as it was reported to develop a tuneable band gap upon mechanical stress and electrical gating [4]. Among the well-known methods of graphene growth as mechanical exfoliation (characterized with very low concentration of structural defects, however with limited industrial applications due to the lack of thickness, size and location control), chemical vapor deposition (CVD) turns out to be the most prospective, inexpensive and readily accessible approach to satisfy the complex requirements of optoelectronics and microelectronics for large-area, high-quality graphene with low-density of structural defects.

During the CVD process, transition metals as Cu, Ni, Fe, play a fundamental role in reducing the decomposition temperature of methane [5]. One essential limitation of utilizing Ni as deposition substrate is that single- and few-layered graphene is obtained only over few-micron regions and the film is not homogeneous and with no uniform thickness over the entire substrate. The impossibility to control the number of layers is partially due to the fact that the segregation of carbon from the metal carbide upon cooling occurs rapidly within the Ni grains and heterogeneously at the grain boundaries.

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[6]. In contrast, the peculiar combination of very low affinity between carbon and copper combined with the ability to form transient soft bonds facilitates formation of nucleation sites on the copper foil surface that form preferentially single-layer graphene through lateral growth [5]. In that aspect Cu is the perfect candidate for making large area, single layer graphene films with uniform thickness due to the low solubility of carbon in Cu.

In this work we study CVD growth of graphene on copper foil as well as the plasma-enhanced CVD growth of carbon nanotubes. We characterize the obtained samples with Raman spectroscopy and discuss some consequences of the transfer of graphene layers on Si wafers.

2. Experimental

The graphene samples were grown in quartz tube furnace by a CVD method involving high purity methane (99.9995%) and hydrogen gases. The growth procedure is displayed in figure 1. Under vacuum of 270 mTorr, the furnace is heated with 50 sccm flow of H₂. When temperature is stabilized at 1000 °C, the hydrogen flux is decreased to 20 sccm and methane is introduced into the tube while keeping the pressure around 630 mTorr to grow graphene for 20 min. Rapid cooling is then applied after growth, and methane and hydrogen gas flows are continued throughout the cooling process until the temperature falls below 200 °C.

![Figure 1. Stages of the graphene growth procedure.](image)

To transfer the obtained graphene we used a spin coater to deposit photoresist PMMA (A4) on the top of the graphene layer to mechanically support graphene after copper is etched away. Fe(NO₃)₃.9H₂O was used as copper etchant. The PMMA/graphene/Cu foil was put to float in the etchant solution to selectively etch out the Cu-foil. Afterwards the obtained the PMMA/graphene layer was rinsed several times with doubly ionized water and transferred to a SiO₂/Si substrate, followed by removal of the PMMA using hot acetone.

Carbon nanotubes were grown in an Oxford Instruments Plasmalab 100 reactor from C₂H₂ gas precursor in a mix of Ar and H₂ as carrier and NH₃ as additional radical source (gas purity 99.999 %) at a temperature in the range 800–950 °C at chamber pressure 1.5 Torr. The NH₃:CH₄:H₂ ratio was maintained constant at 10:3:20 by mass-flow controllers regardless of the chamber total pressure. The chamber features a hot table consisting of a meandered sheet metallic heater and graphite susceptor Ceramic heat shields around the hot plate were used to reflect emitted radiation thus reducing heating power loss. The gas mixture entered the reaction space through a showerhead. Capacitively coupled RF (13.56 MHz) plasma was ignited between the showerhead and the grounded hot table both in the pretreatment and the growth step. Some of the chamber construction details, the substrate holder and the high temperature furnace arrangement are shown in the figures. The substrates were semiconductor...
silicon wafers coated with TiN diffusion barrier and 5 nm Ni catalyst film. The latter was activated by plasma treatment at the growth temperature in a predeposition step.

The Raman spectra were measured on a Jobin Yvon Labram spectrometer with a CCD detector and entrance slits set to 1.5 cm$^{-1}$ spectral width. The 632.8 nm line of a He/Ne-laser and the 488 nm line of an Ar$^+$ laser were used for excitation, the absolute accuracy being 1 - 2 cm$^{-1}$. The laser beam with power not surpassing 0.5 mW was focused on a spot of about 1 - 2 $\mu$m in diameter on the sample surface using microscope optics with an objective of x50 magnification.

Electrical measurements for determination of the carrier mobility were performed by means of silver-paste contacts.

3. Results and Discussion

3.1. Growth and characterization of graphene

The Raman spectrum of graphene and carbon nanotubes has several unique features [7,8]. The G-band at around 1580 cm$^{-1}$ arises from an $E_{2g}$ zone-center vibration of the sp$^2$-hybridized carbon network. The D-band is a double-resonant (DR) defect-induced feature arising from a breathing-like vibration at the Brillouin zone boundary (K point) [9]. Its frequency is excitation-energy dependent and normally varies in the interval 1320 – 1360 cm$^{-1}$ for visible laser energies. The 2D band is the second order of the D band and is also excitation-energy dependent. Since momentum conservation is provided by two phonons with opposite wave vectors, no defects are required for the DR activation process of the 2D band. Thus the intensity ratio $I(D)/I(2D)$ of the D band and the 2D band is proportional to the amount of structural defects. Another DR defect-induced feature is the D’ mode ($\approx$1620 cm$^{-1}$) involving vibrations near the $\Gamma$ point. Combination modes of graphene in the intermediate frequency range are the so-called M-band at $\approx$1750 cm$^{-1}$ (absent in single-layer and twisted (non-AB-stacked) double-layer graphene) and a doublet between 1800 and 2100 cm$^{-1}$ [10]. The defect-induced combination mode of the D and D’ band appears at $\approx$ 2920 cm$^{-1}$ [8]. Around 2450 cm$^{-1}$ there is another characteristic band for graphene-based materials denoted as G* which arises from the combination mode of iTO phonons and longitudinal acoustical (LA) phonons [8]. Finally, non-dispersive bands activated by the mutual perturbation of adjacent layers in twisted double-layer graphene, called the I-band were reported recently to lie on the higher-energetic side of the D-band [11], and may facilitate distinguishing the AB-stacked bilayer graphene from the twisted one [12].

Figure 2. Optical micrograph of the obtained graphene film after transfer on Si/SiO$_2$.

In the Raman spectrum of graphene, the ratio between the intensity of the G band and the 2D band ($I(G)/I(2D)$), the lineshape of the 2D band and its width (FWHM) can be used as a measure for the number of single-atomic layers as the 2D band has characteristic lineshapes for mono- and bi-layer graphene, due to differences in their electronic structure [7,8]. In characterising single-layer graphene
(SLG) and discriminating between it and the various kinds of bilayer graphene (BLG) we consider the 2D peak frequency the most important parameter as it blue-shifted [13] with respect to that of SLG for any arbitrary twisting angle between the two layers of BLG [14]. On the other hand, a 2D peak with single-Lorentzian shape of BLG was found to be in some cases even narrower than that of SLG [14]. In the following analysis we will use also the second-order modes for additional confirmation of our conclusions.

Figure 2 shows an optical microscope image of the obtained graphene transferred from the Cu foil to Si/SiO$_2$. Obviously, there are highly uniform regions with size of several tens of $\mu$m$^2$ without any visible change in contrast. To investigate the quality and proof the visible homogeneity of the synthesized graphene films spot-resolved Raman measurements were performed over those regions. Figure 3 shows representative Raman spectra of the obtained graphene both as grown on Cu foil and transferred onto SiO$_2$/Si substrate excited at 2.54 eV.

![Figure 3. Raman spectra of the obtained graphene film recorded “as grown” and after transfer onto Si/SiO$_2$ as marked in the figure. Asterisks mark important intermediate bands: the doublet between 1800 and 2100 cm$^{-1}$ and the probable superlattice feature at $\approx$ 1375 cm$^{-1}$. To enable reliable comparison the spectra are normalized to the same G-band intensity.](image)

The obtained graphene exhibits FWHM (2D) of 37 cm$^{-1}$ and I(2D)/I(G) $\sim$ 2.5. Low-intense but well-formed defect-induced bands (I(D)/I(G) $< 0.05$) are observed. The 2D lineshape is fitted with a single Lorentzian centered around 2690 cm$^{-1}$. These findings indicate SLG with few defects [15]. Surprisingly, the transfer onto SiO$_2$/Si seems to diminish the amount of structural defects as the defect-induced modes D, D' and D+D' are weaker after transfer (see figure 3). On the other hand, transfer onto SiO$_2$/Si probably leads to partial overlap and creation of folded BLG. This is indicated by the blue-shift ($5-10$ cm$^{-1}$) of the 2D band and decrease of the I(G)/I(2D) ratio after transfer as well as by the appearance of a new band around 1450 cm$^{-1}$, which falls in the region of appearance of perturbation-induced bands, indicative of bilayer superlattice structures [12]. Examination of the combination modes in figure 3 confirms the presence of SLG. The asymmetric shape of the excitation-energy dependent D* band is typical for single-layer graphene [16]. The M-band at $\approx$1750 cm$^{-1}$ is
completely absent in all spectra and shape and frequency of the doublet between 1800 and 2100 cm$^{-1}$ are characteristic for SLG Raman spectra excited at 488 nm [10].

The 2D band blue shift could also be due to PMMA-residues from the transfer process that usually turns graphene into p-type doping [17]. The lack of large doping-induced shift of the G-band above 1586 and the sufficiently high $I(2D)/I(G)$ ratio [18,19] in all spectra, however, give us confidence that the doping level of our samples, if any, is sufficiently low. Likewise, the lack of strain-induced changes in the shape of the G- and 2D band shows that possible transfer-induced wrinkles are below detectable limit. These additional arguments are important as both charged impurities and strain do not contribute to the D band [8] and their influence cannot be assessed from the D band intensity.

The sheet resistance of the obtained graphene was established to be 1810 $\Omega$/sq with a carrier mobility slightly over 1000 cm$^2$/Vs. The high resistance value is not surprising if one takes into account the contact resistance to the silver paste and the polycrystallinity of the graphene layer. Sheet resistance of similar-quality graphene measured via thermally evaporated gold electrodes [20] was found to barely surpass 1000 $\Omega$/sq. This gives us confidence that the intrinsic sheet resistance of the obtained graphene is of the order of several hundreds $\Omega$/sq which makes it suitable for application as transparent conductor in optoelectronics.

3.2. Growth and characterization of carbon nanotubes
Vertically aligned carbon nanotubes were grown on Ni/TiN/Si substrates from acetylene precursor after catalyst nanoparticles activation in hydrogen plasma [21]. Growth occurs via carbon species adsorption, surface migration and trapping at atomic steps at the Ni nanoparticles’ surface. The growing nanotube detaches from the substrate the catalytic particle which stays at the nanotube tip and to a large extent defines the nanotube diameter. Tube growth terminates when all the catalytic particle surface gets completely covered with a crust of fixed non-mobile carbon species. NH$_3$ provides cyano–containing radicals in the plasma which combine with acetylene–derived species to produce the carbon source at the catalytic seed surface thus lowering the needed free energy change. The RF electric field provides orienting force that keeps top-seeded growth morphologically stable. This produces straight nanotubes aligned perpendicular to the substrate. Scanning electron microscopy (not shown) identified all nanotubes to be multi-walled and therefore of metallic nature with a length of about 1.2 $\mu$m.

![Figure 4. Raman spectra of CVD grown carbon nanotubes.](image-url)
Figure 4 displays representative Raman spectra of the obtained carbon nanotubes. The spectra exhibit the typical Raman features of multiwalled carbon nanotubes. The high intensity of the double resonant defect-dependent bands D and D' points to a considerable amount of defects. This is, however, typical for multiwalled carbon nanotubes which contain a lot of incommensurate structures. Furthermore, the intensity ratio I(D)/I(2D), though varying over the sample, remains below unity indicating that the honeycomb lattice of the distinct walls is not deteriorated by the defects.

4. Conclusion
Single-layer graphene films were grown on Cu foil substrates by low-pressure chemical vapour deposition. Raman characterization of the obtained Cu layers reveals single-crystal graphene with little amount of defects and good homogeneity. We observe spectroscopic indication for small fraction of bilayer graphene on the sample transferred onto silicon and explain this with a possible partial folding during the transfer process. The spectroscopic characterization and the assessment of the electrical properties reveal good-quality graphene suitable for application as transparent conductor in hybrid optoelectronic structures. Straight aligned perpendicular to the substrate carbon nanotubes were grown by plasma-enhanced chemical vapour deposition and characterized with Raman spectroscopy. The majority of them are multi-walled and therefore of metallic nature.

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6. References
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